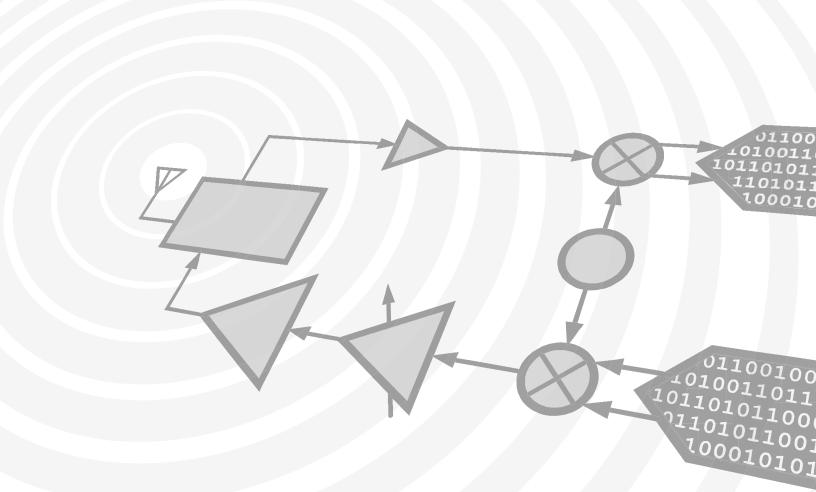
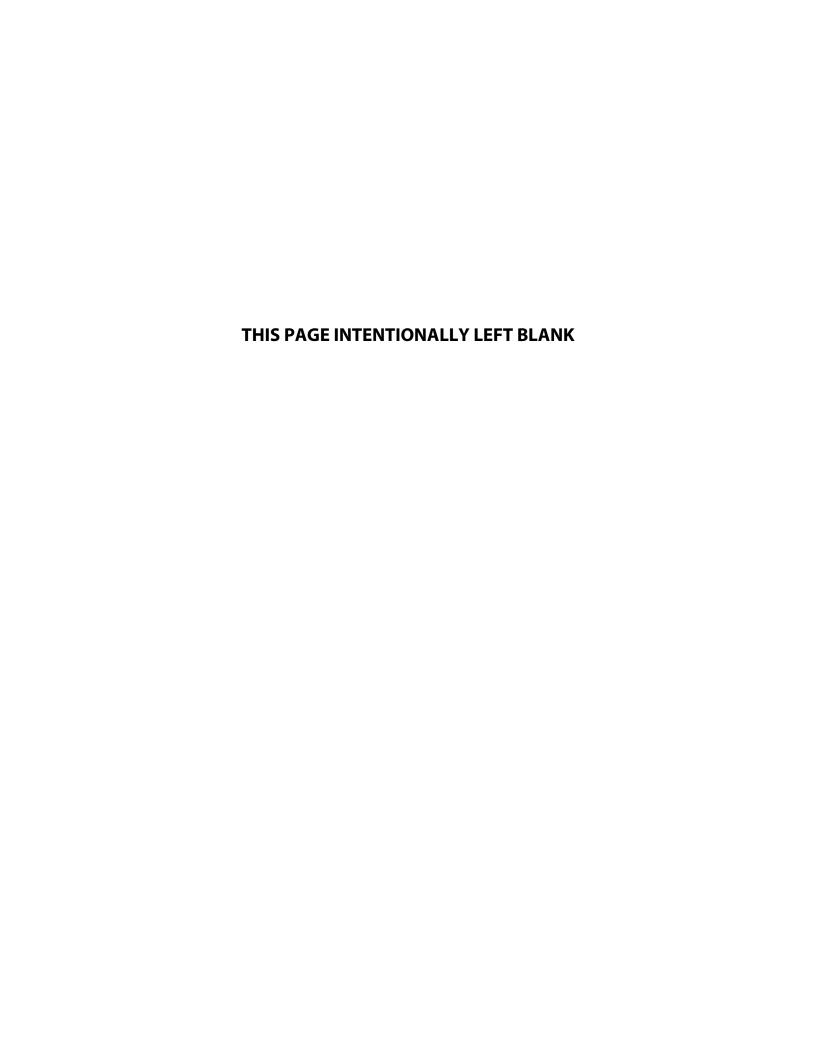




Analog Devices Welcomes Hittite Microwave Corporation

NO CONTENT ON THE ATTACHED DOCUMENT HAS CHANGED





MILITARY MANUFACTURING

Standard & Custom Products, DC to 110 GHz!



Analog, Digital & Mixed-Signal ICs, Modules, Subsystems & Instrumentation

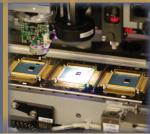


Facilities, Manufacturing & Test

- ♦ ISO 9001:2008 & AS9100:2009
- ♦ Class 100 Environment for S-Level Products
- ♦ Automatic Hybrid Assembly Equipment: Die Inspect/Pick, Die/Substrate Attach & Wire Bond
- ♦ IR Reflow Equipment for PCB Based Assemblies
- ♦ Automated Digital Product Test to 40 Gbps
- ♦ Automated RF, Microwave & Millimeterwave Product Test to 110 GHz









High Reliability Screening & Tests

- ♦ Wafer Lot Acceptance Test (WLAT)
 Bond Pull & Die Shear
 SEM Inspection
 Metal & Dielectric Thickness Meas.
- **♦** Temperature Cycle
- ♦ Constant Acceleration
- ♦ High Temp Burn-In
- ♦ Visual Inspection
- ♦ Vibration
- ♦ Fine & Gross Hermeticity
- ♦ Radiographic Inspection
- ♦ Particle Impact Noise Detection
- ♦ Residual Gas Analysis
- ♦ ESD Characterization
- ♦ Serialized Test Data
- ♦ Qualification Report

Hittite Delivers Qualified Solutions to Meet Your Specific Requirements!



CONTACT Us: mil@hittite.com

MILITARY PRODUCTS

Military Qualified Components, Modules & Subsystems!



Analog, Digital & Mixed-Signal ICs, Modules, Subsystems & Instrumentation







Printing &





Chip (Die)

Dielectric Resonator Oscillator

Hermetic Modules

Hermetic SMT Package











Clock Generator

Integrated Sub-Assembly

FPGA

Switched Filter Bank









Downconverter Serialized Die

FET Channel SE<u>M</u>

Hittite Provides Proven Technical Solutions for Military Applications!

- ♦ Vertical Integration with In-House MMIC & Module Design and Manufacturing
- ♦ Rapid Prototyping Capability Reduces Technical & Schedule Risks
- ♦ Custom IC Development Enables Advanced Performance with Miniature Size
- ♦ IC Manufacturing Infrastructure Provides Benefits in Controlling Performance, Quality, Schedule, Obsolescence, Packaging & Design Optimization
- ♦ Demonstrated Track Record of Industry Leadership and Key Supplier to the World's Most Trusted Defense System Integrators

World-Class IC, Module, and Subsystem Design and Manufacturing Solutions!



CONTACT Us: mil@hittite.com

SPACE MANUFACTURING

Space Qualified Processes, People & Facilities!



Analog, Digital & Mixed-Signal ICs, Modules, Subsystems & Instrumentation



Facilities, Manufacturing & Test

- ♦ ISO 9001:2008 & AS9100:2009
- ♦ Class 100 Environment for S-Level Products
- ◆ Automatic Hybrid Assembly Equipment: Die Inspect/Pick, Die/Substrate Attach & Wire Bond
- ♦ IR Reflow Equipment for PCB Based Assemblies
- ♦ Automated Digital Product Test to 40 Gbps
- ♦ Automated RF, Microwave & Millimeterwave Product Test to 110 GHz





Class S Screening & Qualification

- ♦ VI to Methods 2010A & 2017K
- **♦ Temperature Cycle**
- ♦ High Temperature Burn-In & Life Test
- ♦ Wafer Lot Acceptance Test
 Bond Pull & Die Shear
 SEM Inspection
 Metal & Dielectric Thickness Meas.
- ♦ Serialized Test Data
- ♦ Qualification Report

Hittite Delivers Qualified Solutions to Meet Your Specific Requirements!



CONTACT Us: space@hittite.com

SPACE PRODUCTS

Space Qualified Components, Modules & Subsystems!



Analog, Digital & Mixed-Signal ICs, Modules, Subsystems & Instrumentation



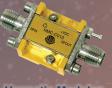














Hermetic MicroSynth™



Downconverter



Switched Filter Bank



Clock Generator











Channel SEM

Hittite Provides Proven Technical Solutions for Space Applications!

- ♦ Space Upscreening to Customer Specifications & Delivered over 45,000 S-Level Components
- ♦ Qualified By Major Spacecraft OEMs
- ♦ Space Level Products, Component & Module Qualification
- ♦ Offers MIL-PRF-38534-K & MIL-PRF-38535-S Class Screening on Die, Hermetic, Packaged Die & **Hybrid Assemblies**
- ♦ Space Grade Components Currently Operational on Dozens of Commercial, Scientific & Military Spacecraft

Your Source for State-of-the-Art Proven Performance!



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